

# Features

- ESD/Surge Protection for 1 Line with Bidirectional.
- Provide ESD protection for each line to IEC 61000-4-2 (ESD) ±30kV (air / contact) IEC 61000-4-4 (EFT) 80A (5/50ns) IEC 61000-4-5 (Lightning) 21A (8/20µs)
- Suitable for, 5.0V and below, operating voltage applications
- Low capacitance : 1.9pF typical
- High surge protection
- Fast turn-on and low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- Green Part

# Applications

- xDSL Line Protection
- WAN/LAN Device
- 10/100/1000 Ethernet
- Power Supply Protection
- USB Interface Protection
- RF Interface Protection
- Peripherals

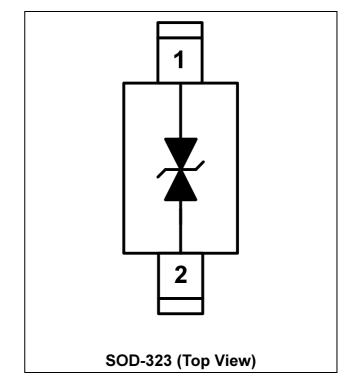
## Description

AZ1615-01L is a design which includes a bi-directional ESD rated clamping cell to protect one power line, or one control line, or one high speed data line in an electronic system. The AZ1615-01L has been specifically designed to protect sensitive components which are connected to data and transmission lines from over-voltage caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

AZ1615-01L is a unique design which includes proprietary clamping cell in a single package. During transient conditions, the proprietary clamping cell prevents over-voltage on the power line or control/data lines, protecting any downstream components.

AZ1615-01L may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge).

# Circuit Diagram / Pin Configuration



1



#### **SPECIFICATIONS**

ABSOLUTE MAXIMUM RATINGS			
PARAMETER	SYMBOL	RATING	UNITS
Peak Pulse Current (tp=8/20µs)	I <sub>PP</sub>	21	А
Operating Supply Voltage	V <sub>DC</sub>	±5.5	V
ESD per IEC 61000-4-2 (Air)	$V_{ESD}$	±30	kV
ESD per IEC 61000-4-2 (Contact)		±30	
Lead Soldering Temperature	T <sub>SOL</sub>	260 (10 sec.)	℃
Operating Temperature	T <sub>OP</sub>	-55 to +125	℃
Storage Temperature	T <sub>STO</sub>	-55 to +150	℃

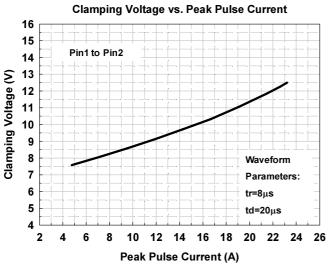
ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNITS
Reverse Stand-Off Voltage	V <sub>RWM</sub>	T=25 ℃	-5.0		5.0	V
Reverse Leakage Current	I <sub>Leak</sub>	V <sub>RWM</sub> = ±5 V, T=25 ℃			0.5	μA
Reverse Breakdown Voltage	$V_{BV}$	I <sub>BV</sub> = 1mA, T=25 ℃	6		9	V
Surge Clamping Voltage		I <sub>PP</sub> = 5A, tp=8/20µs, T=25 ℃		7.5		V
	- GL-Suige	I <sub>PP</sub> = 21A, tp=8/20µs, T=25 ℃		12		-
ESD Clamping Voltage (Note 1)	$V_{clamp}$	IEC 61000-4-2, +8kV (I <sub>TLP</sub> = 16A), Contact mode, T=25 °C		9.5		V
ESD Dynamic Turn-on Resistance	R <sub>dynamic</sub>	IEC 61000-4-2, 0~+8kV, T=25 °C, Contact mode		0.16		Ω
Channel Input Capacitance	C <sub>IN</sub>	V <sub>R</sub> = 0V, f = 1MHz, T=25 ℃		1.9	3.0	pF

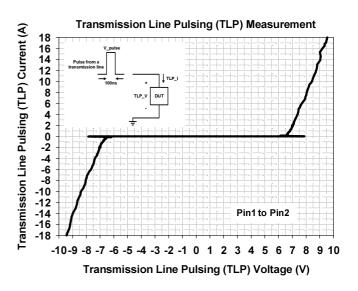
Note 1: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

TLP conditions:  $Z_0$ = 50 $\Omega$ ,  $t_p$ = 100ns,  $t_r$ = 1ns.



## **Typical Characteristics**





#### Typical Variation of $C_{IN}$ vs. $V_{IN}$ 3.0 2.8 2.6 2.4 2.2 2.0 1.8 1.6 1.4 1.2 1.0 Input Capacitance (pF) 0.8 0.6 f=1MHz, T=25°C 0.4 0.2 0.0 -5 -2 2 3 5 -4 -3 -1 0 1 4 Input Voltage (V)



## **Applications Information**

The AZ1615-01L is designed to protect one line against System ESD/EFT/Lightning pulses by clamping it to an acceptable reference. It provides bidirectional protection.

The usage of the AZ1615-01L is shown in Fig. 1. Protected line, such as data line, control line, or power line, is connected at pin 1. The pin 2 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ1615-01L should be kept as short as possible. In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ1615-01L.
- Place the AZ1615-01L near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

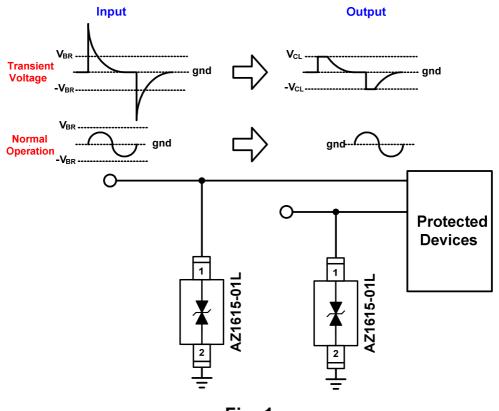
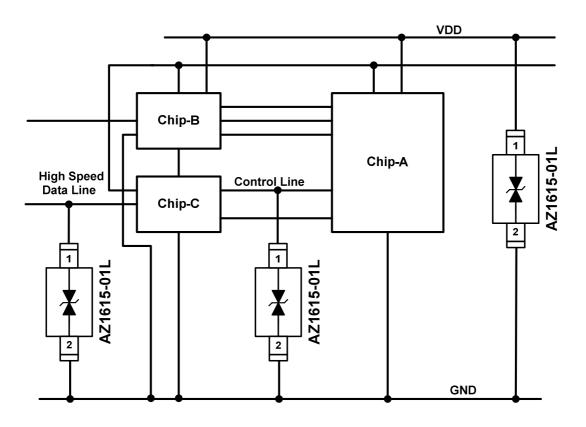






Fig. 2 shows another simplified example of using AZ1615-01L to protect the control line, high

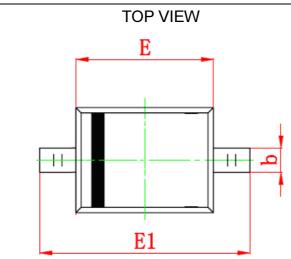
speed data line, and power line from ESD transient stress.



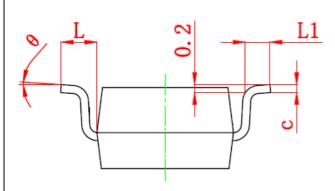




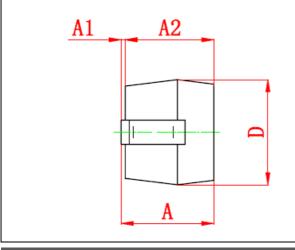
## Mechanical Details SOD-323 PACKAGE DIAGRAMS



## SIDE VIEW



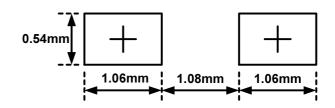
## END VIEW



#### PACKAGE DIMENSIONS

Symbol	Millim	neters	Inches		
	MIN.	MAX.	MIN.	MAX.	
Α	0.8	1.0	0.031	0.039	
A1	0	0.1	0.000	0.004	
A2	0.8	0.9	0.031	0.035	
b	0.25	0.35	0.010	0.014	
С	0.08	0.15	0.003	0.006	
D	1.2	1.4	0.047	0.055	
E	1.6	1.8	0.063	0.071	
E1	2.5	2.7	0.098	0.106	
L	0.475REF		0.019 REF		
L1	0.25	0.4	0.010	0.016	
θ	0°	8°	0°	8°	

## LAND LAYOUT

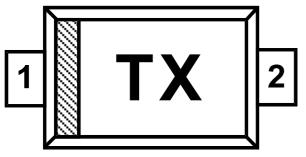


#### Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.



## **MARKING CODE**



Top View

T = Device Code X = Date Code

Part Number	Marking Code
AZ1615-01L.R7G	ТХ
(Green Part)	IA

Note. Green means Pb-free, RoHS, and Halogen free compliant.

## **Ordering Information**

PN#	Material	Туре	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ1615-01L.R7G	Green	T/R	7 inch	3,000/reel	4 reels= 12,000/box	6 boxes =72,000/carton

## **Revision History**

Revision	Modification Description		
Revision 2016/10/14	Preliminary Release.		
Revision 2017/05/11	Formal Release.		